

Risk Factors

Today's presentations contain forward-looking statements. All statements made that are not historical facts are subject to a number of risks and uncertainties, and actual results may differ materially. Please refer to our most recent Earnings Release and our most recent Form 10-Q or 10-K filing available on our website for more information on the risk factors that could cause actual results to differ.

Agenda

- Today's news
- Current environment
- The latest on Intel's mobile platforms
- Ultra-thin laptops come to the mainstream
- Expanded wireless capability
- Summary

This presentation and materials related to it are under embargo until June 1, 2009, 9 p.m. PDT

Today's News

What's launching today:

- Three new Intel® Core®2 Duo processors (T9900, P9700, and P8800)
- New ULV Intel® Pentium® processor (SU2700)
- New Mobile Intel® GS40 Express Chipset

Enabling significant improvements in the four vectors of mobility

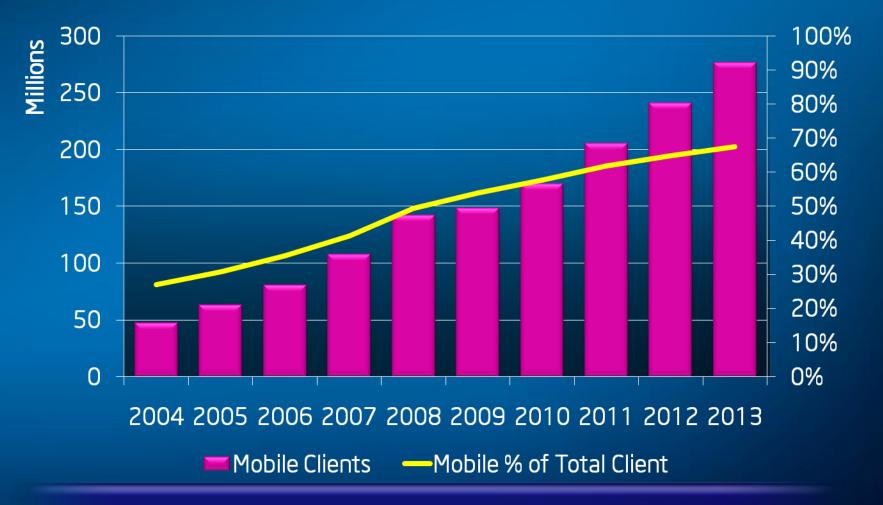
- Extended performance leadership
- Enabling Ultra-thin systems at mainstream price points
- Enhancing battery life
- Expanded wireless capabilities

For more information, go to

http://www.intel.com/pressroom/kits/events/computex2009



Worldwide Mobile Growth Continues

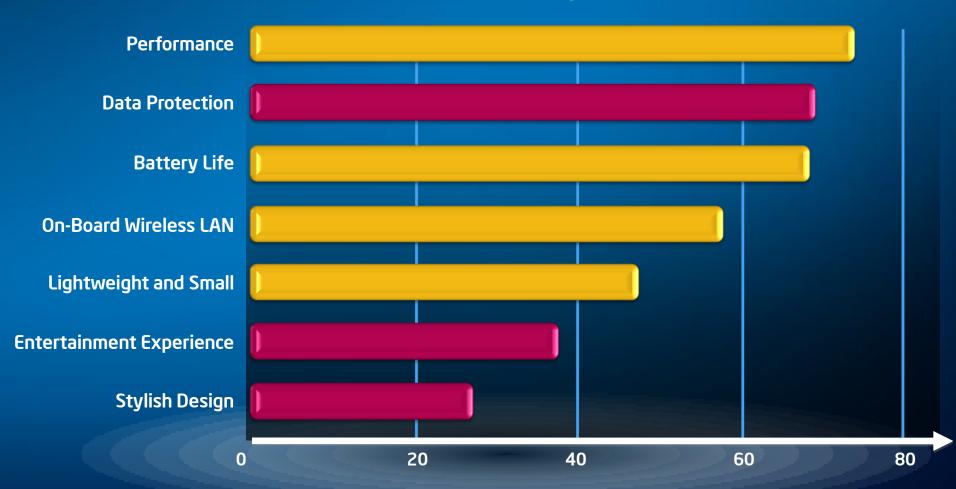


Mobile Shift Strong Across Mature and Emerging Markets



Top Mobile Computing Needs

Relative Feature Importance







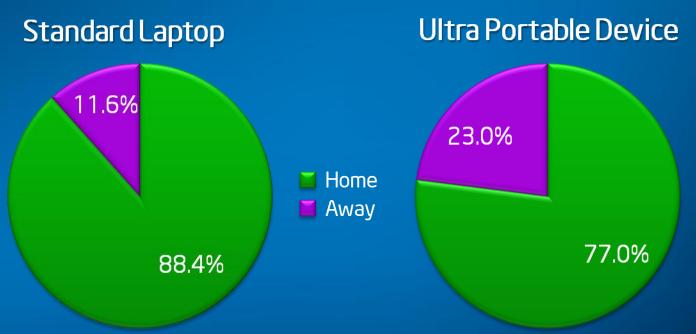








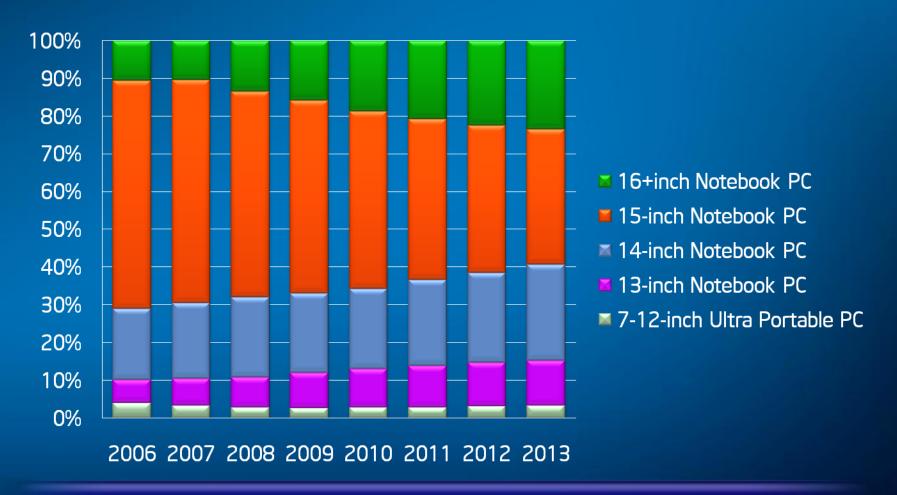
Ultra-thin and Lighter Systems Enable Greater Mobility



Number of times the mobile device is taken outside the home (of the times when end-users are away from home) in percentages

- Smaller devices (such as UMPCs and netbooks) are twice as likely to be taken outside the home than standard laptops
- 55% of laptop PC users cite device weight among reasons for keeping the laptop at home

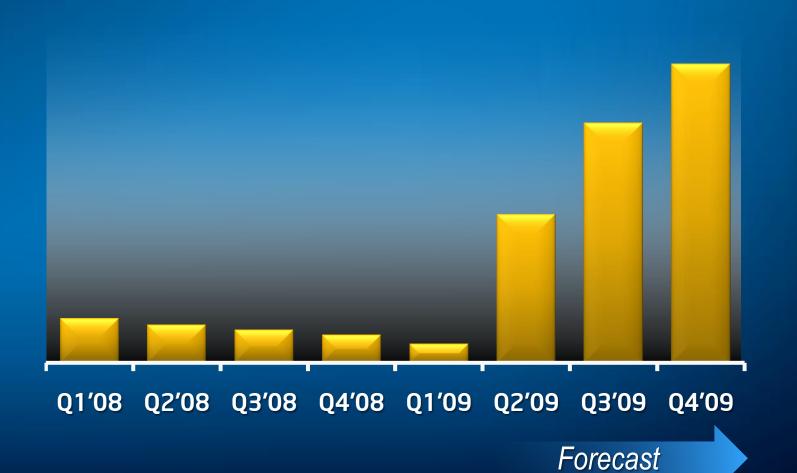
Consumer Laptop Form Factor Trends



Strongest Growth in ≤14-inch and ≥16-inch Segments



Intel Forecasts Even Stronger Growth of the Ultra-thin Segment



INTEL'S BEST JUST GOT BETTER...



Intel® Centrino®2 Processor Technology

Improvements in All 4 Vectors of Mobility!



Extending performance leadership

Now up to 3.06GHZ

Improved HD media and visual quality



Average power leadership

0.8W

Expanded switchable graphics



Enabling new

Affordable ultra-thin laptops

Bringing "thin" to the mainstream



Improved wireless ecosystem

Intel® My WiFi
Technology build out of CE
vendors

WiMAX momentum extends coverage



Compute Intensive and Floating Point Benchmark Intel vs. Intel Running Windows* XP* Professional



SPECint*_rate_base2006





Increased Throughput For Parallel Execution Of Multiple Compute-intensive Applications

Intel® Core™2 Duo processor T9900 (3.06GHz, 6MB L2, 1066MHz FSB), Mobile Intel® GM45 Express Chipset, 2x1GB DDR3 1066 MHz

Intel® Core™2 Duo processor T7800 (2.60GHz, 4MB L2, 800MHz FSB), Mobile Intel® GM965 Express Chipset, 2x1GB DDR2 667 MHz

Intel® Core™ Duo processor T2700 (2.33GHz, 2MB L2, 667MHz FSB), Mobile Intel® 945GM Express Chipset, 2x1GB DDR2 667 MHz





ULTRA-THIN LAPTOPS FOR ALL



Ultra-thin Laptops 20 Years in the Making

2001-2003

Chipset Power Management ACPI 2.0

Deeper Sleep

Deep Power Down

Intel® Smart Cache

Intel® Core Micro-architecture 2004-2009

Intel® High-K Metal Gate 45nm process technology

Intel® DPST revisions 2-4

Enhanced Deeper Sleep

Intel® Dynamic Power Coordination

Ultra Low Voltage
Pentium® III Processors

IMVP II, III, IV Enhanced Intel®

Extended Battery Life SpeedStep™ Technology Initiative (EBL) Banias Micro-architecture

Intel® Centrino® Mobile Technology

1994-1997

Clock Gating

System Management Bus

IMVP

Intel QuickStart Technology

Dynamic Freq/Voltage Scaling Patent

Intel® SpeedStep™ Patent

1989-1994 Voltage

Reduction

Technology
Dynamic PLL
Ratio Scaling
Patent

SMI and Clock Control

i486SL CPU

Advanced Power Mgmt

1997-2000

Intel® SpeedStep™ technology

Low Voltage processors

Mobile Intel®
Pentium® II processor

New Smart
Battery guidelines ACPI

Mobile Intel®
Pentium® III processor

Mobile Intel® Pentium® processor

3.3V PCI

ExCATM I/O standard

Deep Sleep

CPU voltage reduced from 5V to 3.3V

System Management mode

Integrated memory, bus and cache control

16MHz i386SL CPU



Ultra-thin Laptops 20 Years in the Making

2001-2003

Chipset Power Management ACPI 2.0

First Ultra Low Volt Processors

Intel introduces Coppermine-based Mobile Intel® Pentium® III

processors in January 2001

Deeper Sleep

Deep Power Down

Intel® Smart Cache

Intel® Core
Micro-architecture

2004-2009

Intel® High-K Metal Gate 45nm process technology

Intel® DPST revisions 2-4

Enhanced Deeper Sleep

Intel® Dynamic Power Coordination

Ultra Low Voltage Pentium® III Processors

Enhanced Intel®

IMVP II, III, IV

Extended Battery Life SpeedStep™ Technology

Banias Micro-architecture

chnology

<u> 1994-1997</u> 1989-1994

Clock Gating

System Management Bus

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Intel QuickStart Technology

Dynamic Freq/Voltage Scaling Patent

Intel® SpeedStep™ Patent

Voltage Reduction Technology

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SMI and Clock Control

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Pentium® II processor

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Pentium® III processor

Mobile Intel® Pentium® processor

ExCATM I/O standard

Deep Sleep

CPU voltage reduced from 5V to 3.3V

System Management mode

Integrated memory, bus and cache control

16MHz i386SL CPU



A Full Range of Devices for Different User Needs



Netbook

- Device for the Internet
- Purpose built for Internet use
- Web: Learn, Communicate and View
- Compact form factor
- Basic consumption capability



New Ultra-thin Laptop

- Full PC experience with the flexibility of mobility
- Sleek, thinner and lighter
- Multitasking performance & rich internet experience
- Create videos, edit photos, burn CD & DVD
- Quiet cooling solutions
- Lower overall platform power for improved battery life

Standard Laptop

- Multi-purpose PCs
- Entertainment, productivity, and rich web experience
- View, create or edit HD video
- Content creation and Intense workloads
- Range of form factors



Expanding the Ultra-thin Segment Solution for Every Segment and Price Point





Best Media Experience

Better



Great Media Experience

Good



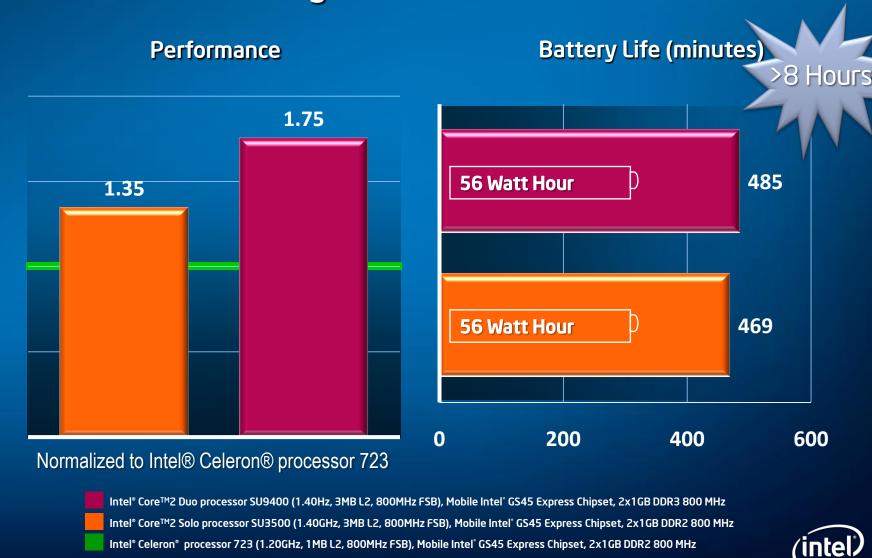
Mainstream System Performance

Entry



Entry Level System Performance

MobileMark* 2007 - Office Productivity Intel vs. Intel running Windows* Vista* Home Premium



Strong Momentum, Stunning Innovation





























SONY.

TOSHIBA



Tracking Over 40 OEM Design Wins





Notable Global WiMAX Deployments

Includes Plans For 802.16e Deployment



* WiMAX Forum, March 2009

430 Million Pops covered today Target 800 Million Pops by 2010*



WiMAX Embedded Laptops & Netbooks Scaling to over 100 Models by EOY 2009

16 OEMs have announced WiMAX support

Acer, ASUS, Clarion, Dell, Epson, Fujitsu, HP, Lenovo, MSI, NEC, Onkyo, Panasonic, Samsung, Sharp, Sony, Toshiba

US

35+ certified models from 6 OEM's

20+ Models available in U.S. Channels NOW

Japan

14 OEMs commitment to embed WiMAX

Russia

24 mobile PC's - 6 OEM's

Scaling to over 100 Models by EOY 2009









Summary



Longer Battery Life



Higher Performance



Ultra-thin Form Factors



Seamless PC & CE sync



Internet In New Places

Go Mobile! Unleash a World of Possibilities.



Intel at Computex, Taiwan

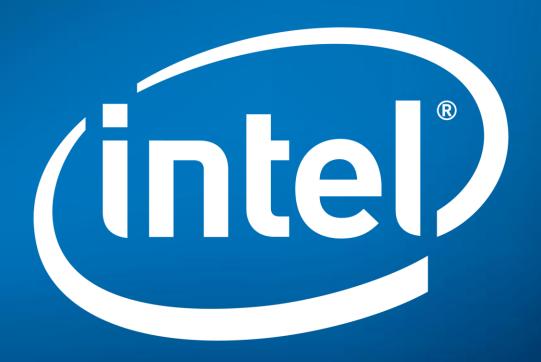
June 2 – Sean Maloney Keynote, "Innovate for Growth" and Mooly Eden Mobility Event, "Mobility: Unleash a World of Possibilities"

June 3 – Moblin Industry Event and Rob Crooke, "Accelerating Innovation in the Desktop" Desktop Event

June 4 - Anand Chandrasekher, "The Art of Possible" UMG Event

Press materials for these events as well as webcast for replay available at

http://www.intel.com/pressroom/kits/events/computex2009



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System performance, battery life, power savings, high-definition quality, video playback and functionality, and wireless performance and functionality will vary depending on your specific operating system, hardware, chipset, connection availability and rate, site conditions, and software configurations. References to enhanced performance including wireless refer to comparisons with previous generation Intel technologies. Wireless connectivity and some features may require you to purchase additional software, services or external hardware. See http://www.intel.com/products/centrino/index.htm and http://www.intel.com/go/consumerbenchmarks for more information on performance, wireless, power savings and energy efficiency.

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Wireless N standard currently not available in all countries. Check with your PC and access point manufacturer for details.

Wi-Fi Personal Area Network refers only to WiFi-enabled devices connecting to the PC via the Intel® My WiFi Technology. Wi-Fi devices must be certified by the Wi-Fi Alliance for 802.11b/g/a. Check with your PC manufacturer for more details."

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Relative performance for each benchmark is calculated by taking the actual benchmark result for the first platform tested and assigning it a value of 1.0 as a baseline. Relative performance for the remaining platforms tested was calculated by dividing the actual benchmark result for the baseline platform into each of the specific benchmark results of each of the other platforms and assigning them a relative performance number that correlates with the performance improvements reported.

Benchmark Disclaimer

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SPECint*_rate_base2006 and SPECfp*_rate_base2006 are capacity-based metrics used to measure throughput of a computer that is performing a number of tasks. This is achieved by running multiple copies of each benchmark simultaneously with the number of copies set to set to the number of logical hardware cores seen by the operating system. SPEC* CPU2006 provides a comparative measure of compute intensive performance across the widest practical range of hardware. The product consists of source code benchmarks that are developed from real user applications. These benchmarks depend on the processor, memory and compiler on the tested system.

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Notebook PC Configurations Used for SPEC*CPU 2006

Intel® Mobile Platform	Intel® Centrino®2 Processor Technology	Intel® Centrino®2 with vPro™ Technology	Intel® Centrino®2 with vPro™ Technology
OEM Laptop	Lenovo ThinkPad* T60	Lenovo ThinkPad* T61	Lenovo ThinkPad T400
Processor Name	Intel® Core™ Duo processor T2700	Intel® Core™2 Duo processor T7800	Intel® Core™ 2 Duo processor T9900
Processor Speed	2.33 GHz	2.60 GHz	23.060 GHz
Processor Secondary Cache	2MB Level 2 Cache	4MB Level 2 Cache	6MB Level 2 Cache
Front Side Bus	667 MHz	800 MHz	1066 MHz
Chipset	Mobile Intel® 945GM Express Chipset	Mobile Intel® GM965 Express Chipset	Mobile Intel® GM45 Express Chipset
Chipset INF File	Intel® INF 8.1.1.1010	Intel® INF 8.2.0.1012	Intel INF 8.7.0.1007
Platform BIOS	Lenovo* 79ETD7WW 2.17 with default settings	Lenovo* V.7LETA4WW 1.14 with default settings	Lenovo 7UET57WW 2.03 with default settings
System Memory	Micron* PC5300 DDR2 667 2x1GB 5-5-5-15	Micron PC26400 DDR2 800 2x1GB 5-5-5- 15	Micron MT8JSF12864HY-1G1D1 DDR3 1067 2x1GB 7-7-7-20
Hard Disk	Hitachi* Travelstar* HTS721010G9SA00 SATA 100GB 7200RPM	Hitachi Travelstar HTS721010G9SA00 SATA 100GB 7200RPM	Hitachi Travelstar HTS722020K9SA00 SATA 200GB 7200RPM
Video Controller	Intel® GMA 950	Intel® GMA X3100	Intel® GMA4500HD
Video Driver Version	6.14.10.4926	6.14.10.4926	6.14.10.5002
Graphics	1024x768 resolution, 32-bit color	1024x768 resolution, 32-bit color S	1440x900 resolution, 32-bit color S
Screen Size	14.1" XGA	14.1" XGA	14" WXCA
Sound Card	SoundMAX* Digital HD Audio	SoundMAX Digital HD Audio	Conexant* HD SmartAudio 221
Network Card	Intel® PRO/1000 PL	Intel® 82566MM Gigabit	Intel® 82567LM Gigabit
Wireless Network Card	Intel® PRO/Wireless 3945ABG with driver 11.5.0.36	Intel® Wireless WiFi Link 4965AGN with driver 11.1.1.11	Intel Wireless WiFi Link 5300AGN with driver 12.1.0.14
Operating System	Microsoft* Windows* XP Professional, Build 2600, SP2 NTFS	Microsoft Windows XP Professional, Build 2600, SP2 on NTFS	Microsoft Windows XP Professional, Build 2600, SP2 on NTFS
DirectX* Version	DirectX 9.0c	DirectX 9.0c	DirectX 9.0c
Power Management Mode	High Performance	High Performance	High Performance

Notebook PC Configurations Used for MobileMark* 2007

Intel® Mobile Platform	Intel® Celeron® processor	Intel® Core™2 Solo processor	Intel® Core™2 Duo processor
OEM Laptop	Acer Aspire 3410T	Acer Aspire 3810T	Acer Aspire 3810T
Processor Name	Intel® Celeron® Duo processor 723	Intel® Core™2 Solo processor SU3500	Intel® Core™2 Duo processor SU9400
Processor Speed	1.20 GHz	21.40 GHz	1.40 GHz
Processor Secondary Cache	1MB Level 2 Cache	3MB Level 2 Cache	3MB Level 2 Cache
Front Side Bus	800 MHz	800 MHz	800 MHz
Chipset	Mobile Intel® GS45 Express Chipset	Mobile Intel® GS45 Express Chipset	Mobile Intel® GS45 Express Chipset
Chipset INF File	Intel INF 9.0.0.1011	Intel INF 9.0.0.1011	Intel INF 9.0.0.1011
Platform BIOS	Phoenix* Technologies LTD V.R0111N0	Phoenix Technologies LTD V.R0111S5	Pre-production Phoenix Technologies LTD V.R0260Y1
System Memory	Elpida* 2x1GB DDR3-800 6-6-6-12	Elpida* 2x1GB DDR3-800 6-6-6-12	Elpida* 2x1GB DDR3-800 6-6-6-12
Hard Disk	Seagate* ST9250315AS SATA-2 250GB 5400RPM	Seagate* ST9250315AS SATA-2 250GB 5400RPM	Seagate* ST9250315AS SATA-2 250GB 5400RPM
Video Controller	Intel® GMA 4500(M)(HD)	Intel® GMA 4500(M (HD)	Intel® GMA 4500(M)(HD)
Video Driver Revision	7.15.10.1666	7.15.10.1666	7.15.10.1666
Graphics	1366x768	1366x768	1366x768
Screen Size	13.3"	13.3"	13.3"
Network Card	Atheros AR8131 PCI-E Gigabit Ethernet Controller	Atheros AR8131 PCI-E Gigabit Ethernet Controller	Atheros AR8131 PCI-E Gigabit Ethernet Controller
Wireless Network Card	Intel WiFi Link 51000 AGN with driver 12.2.0.11	Intel WiFi Link 51000 AGN with driver 12.2.0.11	Intel WiFi Link 51000 AGN with driver 12.2.0.11
Operating System	Microsoft* Windows* Vista* Home Premium, Build 6001 SP1 on NTFS	Microsoft Windows Vista Home Premium, Build 6001 SP1 on NTFS	Microsoft Windows Vista Home Premium, Build 6001 SP1 on NTFS
DirectX* Version	DirectX 10	DirectX 10	DirectX 10

Benchmark Disclaimer

MobileMark* 2007 is a benchmark used to evaluate notebook PC user experience by measuring both performance and battery life at the same time on the same workload. MobileMark 2007 was released in August 2007 and contains workloads that are updated from those found in MobileMark* 2005. Because the workloads within MobileMark 2007 and MobileMark 2005 are different and operating system features between Microsoft Windows XP* and Microsoft Windows Vista* also differ, it is not meaningful to compare the performance scores or battery life results of these two benchmarks.